

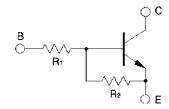
COMPOUND TRANSISTOR BB1 SERIES

on-chip resistor NPN silicon epitaxial transistor For mid-speed switching

The BB1 Series is an N type small signal transistor and enables the reduction of component counts and downsizing of sets due to on-chip resistors. This transistor is especially ideal for use in household electronic appliances and OA equipments such as VCRs and TVs.

FEATURES

- Up to 0.7 A current drive available
- · On-chip bias resistor
- · Low power consumption during drive



QUALITY GRADES

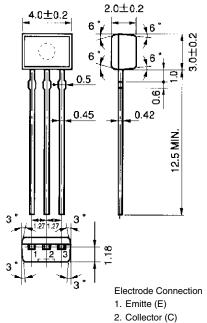
Standard

Please refer to "Quality Grades on NEC Semiconductor Devices" (Document No. C11531E) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

BB1 SERIES LISTS

Products	R ₁ (KΩ)	R ₂ (KΩ)
BB1A4A	-	10
BB1L2Q	0.47	4.7
BB1A3M	1.0	1.0
BB1F3P	2.2	10
BB1J3P	3.3	10
BB1L3N	4.7	10
BB1A4M	10	10

PACKAGE DRAWING (UNIT: mm)



Collector (C)
 Base (B)

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base volgate	Vcво	30	٧
Colletor to emitter voltage	Vceo	25	V
Emitter to base voltage	VEBO	10	V
Collector current (DC)	Ic(DC)	0.7	Α
Collector current (Pulse)	IC(pulse)Note 1	1.0	Α
Base current (DC)	I _{B(DC)}	0.02	Α
Total power dissipation	Рт	250	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	−55 to +150	°C

Note 1 PW \leq 10 ms, duty cycle \leq 50 %

BB1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = 30 V, I _E = 0			100	nA
DC current gain	hFE1 ^{Note 2}	Vce = 2.0 V, Ic = 0.1 A	300			_
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135			-
Collector saturation voltage	VCE(sat) Note 2	Ic = 0.5 A, I _B = 5 mA		0.27	0.4	V
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R ₁		-	-	-	Ω
E-to-B resistance	R ₂		7	10	13	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

BB1L2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 30 V, IE = 0			100	nA
DC current gain	hFE1 ^{Note 2}	VcE = 2.0 V, Ic = 0.1 A	150	400		ı
DC current gain	hFE2 Note 2	Vce = 2.0 V, Ic = 0.5 A	300	700		ı
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135	600		ı
Low level output voltage	Vol. Note 2	$V_{IN} = 5.0 \text{ V}, \text{ Ic} = 0.5 \text{ A}$		0.2	0.3	٧
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	٧
Input resistance	R ₁		329	470	611	Ω
E-to-B resistance	R ₂		3.29	4.7	6.11	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

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BB1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = 30 V, I _E = 0			100	nA
DC current gain	hFE1 ^{Note 2}	Vce = 2.0 V, Ic = 0.1 A	80			-
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	100			_
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135			-
Low level output voltage	Vol. Note 2	V _{IN} = 5.0 V, Ic = 0.5 A		0.3	0.4	V
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V, Ic} = 100 \mu\text{A}$			0.3	V
Input resistance	R ₁		0.7	1.0	1.3	kΩ
E-to-B resistance	R ₂		0.7	1.0	1.3	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

BB1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = 30 V, I _E = 0			100	nA
DC current gain	hFE1 ^{Note 2}	Vce = 2.0 V, Ic = 0.1 A	300			-
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135			_
Low level output voltage	Vol. Note 2	V _{IN} = 5.0 V, Ic = 0.3 A			0.3	V
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R ₁		1.54	2.2	2.86	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

BP1J3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 30 V, IE = 0			100	nA
DC current gain	hFE1 ^{Note 2}	Vce = 2.0 V, Ic = 0.1 A	300	600		_
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	300	700		-
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135	600		-
Low level output voltage	Vol. Note 2	V _{IN} = 5.0 V, Ic = 0.2 A		0.14	0.3	V
Low level input voltage	VIL Note 2	$V_{CE} = 5.0 \text{ V, Ic} = 100 \mu\text{A}$			0.3	V
Input resistance	R ₁		2.31	3.3	4.29	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

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BB1L3N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = 30 V, I _E = 0			100	nA
DC current gain	hFE1 ^{Note 2}	Vce = 2.0 V, Ic = 0.1 A	300			-
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hfE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135			-
Low level output voltage	Vol.Note 2	V _{IN} = 5.0 V, Ic = 0.2 A			0.3	V
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R ₁		3.29	4.7	6.11	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

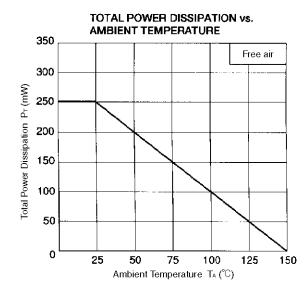
BB1A4M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

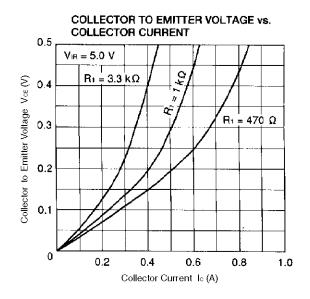
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = 30 V, I _E = 0			100	nA
DC current gain	hFE1 ^{Note 2}	VcE = 2.0 V, Ic = 0.1 A	300			-
DC current gain	hFE2 ^{Note 2}	Vce = 2.0 V, Ic = 0.5 A	300			ı
DC current gain	hFE3 ^{Note 2}	Vce = 2.0 V, Ic = 0.7 A	135			-
Collector saturation voltage	Vol.Note 2	V _{IN} = 5.0 V, Ic = 0.2 A			0.3	V
Low level input voltage	VIL ^{Note 2}	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R ₁		7	10	13	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

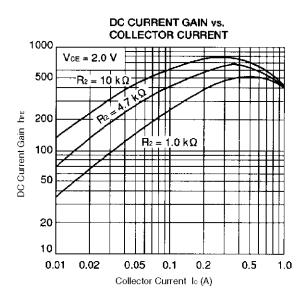
Note 2 PW \leq 350 μ s, duty cycle \leq 2 %

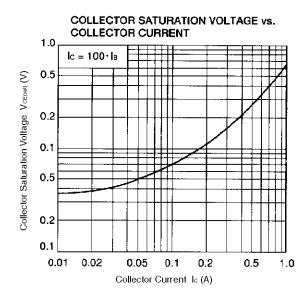


TYPICAL CHARACTERISTICS (Ta = 25°C)









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